# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KEI TANAKA	07/12/2016

### **RECEIVING PARTY DATA**

Name:	HEISHIN LTD.
Street Address:	1-1-54, MISAKIHOMMACHI
Internal Address:	HYOGO-KU
City:	KOBE-SHI
State/Country:	JAPAN
Postal Code:	652-0852

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15114767

## **CORRESPONDENCE DATA**

**Fax Number:** (215)568-3439

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 215-568-3100

Email: assignments@bakerlaw.com
Correspondent Name: BAKER & HOSTETLER LLP

Address Line 1: 2929 ARCH STREET

Address Line 2: CIRA CENTRE, 12TH FLOOR

Address Line 4: PHILADELPHIA, PENNSYLVANIA 19104-2891

ATTORNEY DOCKET NUMBER:	105587.000006	
NAME OF SUBMITTER:	DACIA J. HERNANDEZ	
SIGNATURE:	/Dacia J. Hernandez/	
DATE SIGNED:	07/27/2016	

#### **Total Attachments: 2**

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PATENT 503934863 REEL: 039275 FRAME: 0413

#### ASSIGNMENT

WHEREAS, I, Kei TANAKA, a citizen of Japan, with a mailing address c/o HEISHIN Ltd., Shiga Business Complex, 1020, Higashimonobe, Takatsuki-cho, Nagahama-shi, Shiga 529-0261 Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number 105587.000006 ("the invention"), which is entitled UNIAXIAL ECCENTRIC SCREW PUMP ("the subject application"), a national stage U.S. patent application of International application number PCT/JP2014/082142, filed December 4, 2014, which claims priority to Japanese patent application number 2014-013541, filed January 28, 2014 ("the priority application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, **HEISHIN Ltd.**, ASSIGNEE, having a place of business at 1-1-54, **Misakihommachi**, **Hyogo-ku**, **Kobe-shi**, **Hyogo 652-0852 Japan**, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

PATENT REEL: 039275 FRAME: 0414 DOCKET NO.: 105587.000006

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 12th day of July, year of 2016.
KEI TANAKA Kei TANAKA
***************************************
STATEMENT OF WITNESS
SIGNED at
(City) (Country)
This day of, 2016.
I, whose full
residence address is
was personally present and did see Kei TANAKA execute the above assignment on the day of, 2016, and such assignor is personally known to me to be the person described in such document.
Signature of Witness

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